

SEMICONDUCTOR®

November 2013

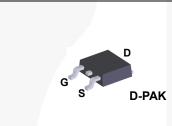
FQD7N10L N-Channel QFET[®] MOSFET 100 V, 5.8 A, 350 mΩ

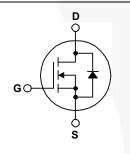
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 5.8 A, 100 V, ${\sf R}_{\sf DS(on)}$ = 350 m Ω (Max.) @ V_{\sf GS} = 10 V, ID = 2.9 A
- Low Gate Charge (Typ. 4.6 nC)
- Low Crss (Typ. 12 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

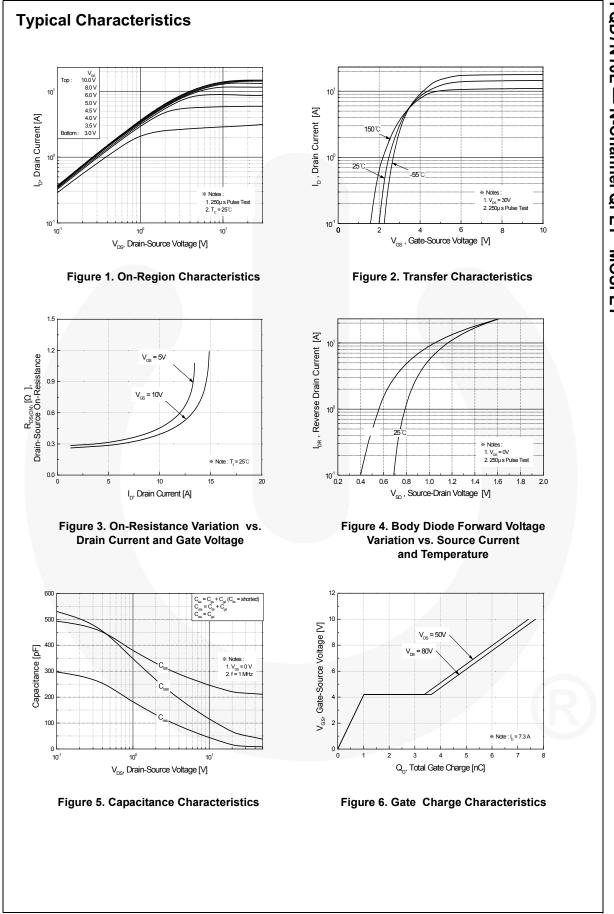
Symbol	Parameter		FQD7N10LTM	Unit	
V _{DSS}	Drain-Source Voltage		100	V	
I _D	Drain Current - Continuous (T _C = 25	°C)	5.8	A	
	- Continuous (T _C = 10	3.67	A		
I _{DM}	Drain Current - Pulsed	(Note 1)	23.2	A	
V _{GSS}	Gate-Source Voltage		± 20	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	50	mJ	
I _{AR}	Avalanche Current	(Note 1)	5.8	A	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	2.5	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns	
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *		2.5	W	
	Power Dissipation (T _C = 25°C)		25	W	
	- Derate above 25°C		0.2	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Ra	nge	-55 to +150		
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

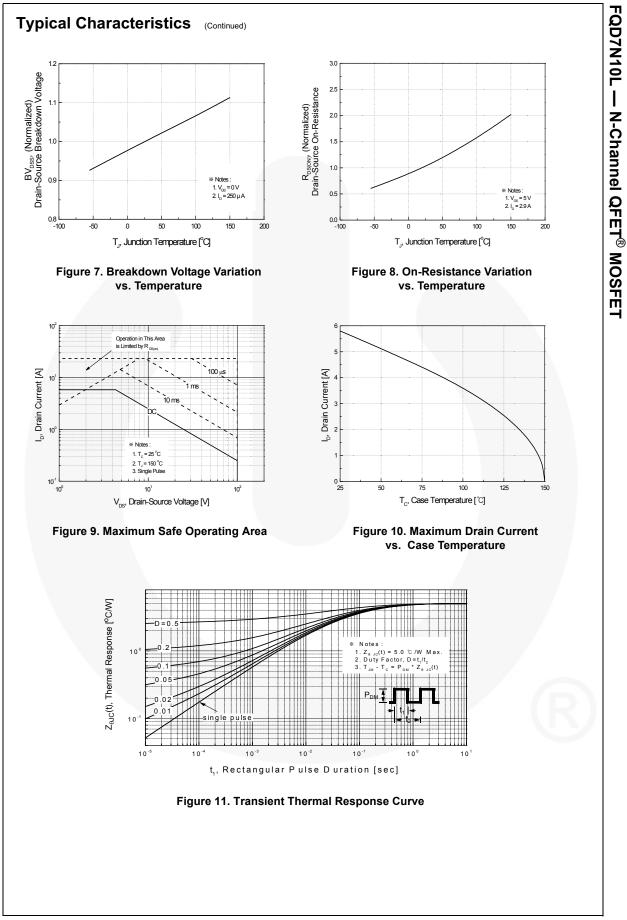
Symbol	Parameter	FQD7N10LTM	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	5.0	
Б	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	

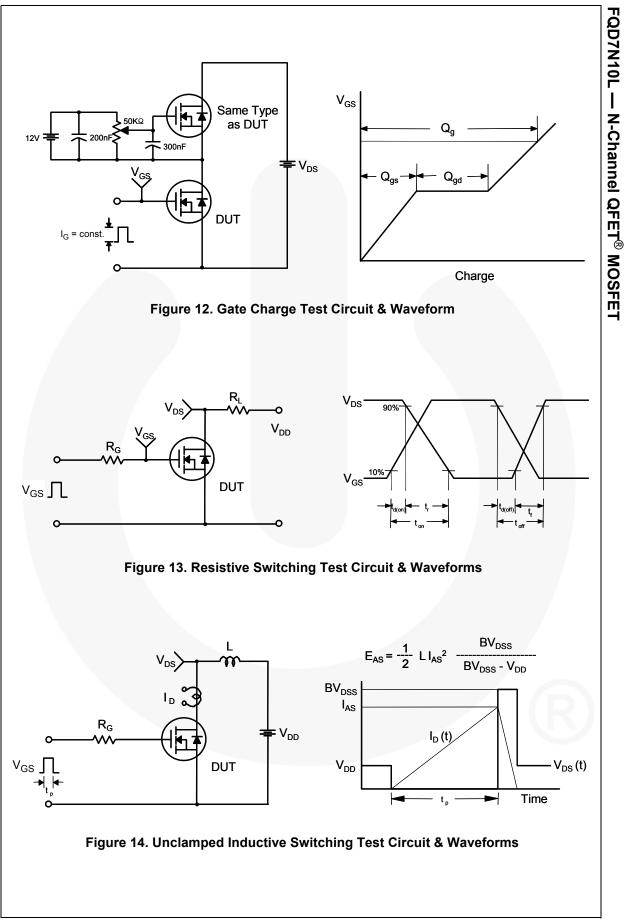
Symbol Symbol Off Char SVDSS ABVDSS ATJ	al Cha	FQD7N10L			age Packing Method	Reel Size		Tape Width		Quantity	
Symbol Off Char BV _{DSS} ABV _{DSS} AT _J	racterist	ractoristics .	QD7N10LTM FQD7N10L D-F		AK Tape and Reel 330		nm	16 mm		2500 units	
Symbol Off Char BV _{DSS} ABV _{DSS} AT _J	racterist	I acter istics	[_ = 25°C un	less otherv	vise noted.						
BV _{DSS} ΔBV _{DSS} ΔT _J		Parameter	C		Test Conditions		Min.	Тур.	Max.	Unit	
BV _{DSS} ΔBV _{DSS} ΔT _J		ice									
ΔBV_{DSS} ΔT_{J}		irce Breakdown Volt	ade	V _{GS} =	0 V, I _D = 250 μA		100			V	
DSS	Breakdown Voltage Temperature Coefficient		I_D = 250 μ A, Referenced to 25°C			0.1		V/°C			
	Zero Gate Voltage Drain Current		$V_{DS} = 100 V, V_{GS} = 0 V$ $V_{DS} = 80 V, T_{C} = 125^{\circ}C$				1 10	μA μA			
GSSF	Gate-Body	Gate-Body Leakage Current, Forward		$V_{GS} = 20 V, V_{DS} = 0 V$					100	nA	
		Gate-Body Leakage Current, Reverse		$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA		
	racterist			65							
		shold Voltage	_	V _{DS} =	V _{GS} , I _D = 250 μA	-	1.0		2.0	V	
R _{DS(on)}	Static Drain-Source On-Resistance			$V_{GS} = 10 V, I_D = 2.9 A$ $V_{GS} = 5 V, I_D = 2.9 A$				0.275 0.300	0.35 0.38	Ω	
ØFS	Forward T	ransconductance	_	$V_{\rm DS} = 30 \text{ V}, \text{ I}_{\rm D} = 2.9 \text{ A}$				4.6		S	
	c Charac	cteristics									
-	Input Cap		_	N -	25.1/1/ - 0.1/			220	290	pF	
	Output Ca		_	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			55	72	pF		
		ransfer Capacitance	`	1 – 1.0	I = 1.0 WHZ			12	15	pF	
r d(off)	Turn-On F Turn-Off D	Delay Time		V _{DD} = R _G = 2	50 V, I _D = 7.3 A, 25 Ω	(Note 4)		100 17	210 45	ns ns	
f	Turn-Off F	· · · · · · · · · · · · · · · · · · ·				. ,		50 4.6	110 6.0	ns nC	
	Total Gate Charge			$V_{\rm DS}$ = 80 V, I _D = 7.3 A,				4.0	0.0	nC	
Qg		reo Chargo	Gate-Source Charge		$V_{GS} = 5 V$ (Note 4)			2.6		-	
λ _g λ _{gs}	Gate-Sou					(Note 4)				nC	
ລ _g ລ _{gs} ລ _{gd} Drain-Sc	Gate-Sour Gate-Drai	n Charge ode Characteri			kimum Ratings	(Note 4)	-	2.0		nC	
ລ _g ລ _{gs} ລ _{gd} Drain-Sc	Gate-Sour Gate-Drai Durce Di Maximum	n Charge ode Characteri Continuous Drain-S	Source Dic	de Forv	vard Current	(Note 4)				nC A	
Ω _g Ω _{gs} Ω _{gd} Drain-Sc s	Gate-Sour Gate-Drai Durce Di Maximum Maximum	n Charge ode Characteri Continuous Drain-S Pulsed Drain-Sourc	Source Dic e Diode F	ode Forv orward	vard Current Current	(Note 4)			23.2	A A	
Q _g Q _{gs} Q _{gd} Drain-Sc s SM V _{SD}	Gate-Sour Gate-Drai Durce Di Maximum Maximum Drain-Sou	n Charge ode Characteri Continuous Drain-S Pulsed Drain-Sourc rrce Diode Forward	Source Dic e Diode F	ode Forv Forward V _{GS} =	vard Current Current 0 V, I _S = 5.8 A	(Note 4)		 		A	
Q _g Q _{gs} Q _{gd} Drain-Sc s SM V _{SD} π	Gate-Sour Gate-Drai Durce Di Maximum Maximum Drain-Sou Reverse F	n Charge ode Characteri Continuous Drain-S Pulsed Drain-Sourc	Source Dic e Diode F	ode Forv Forward V _{GS} = V _{GS} =	vard Current Current	(Note 4)			23.2	A A	

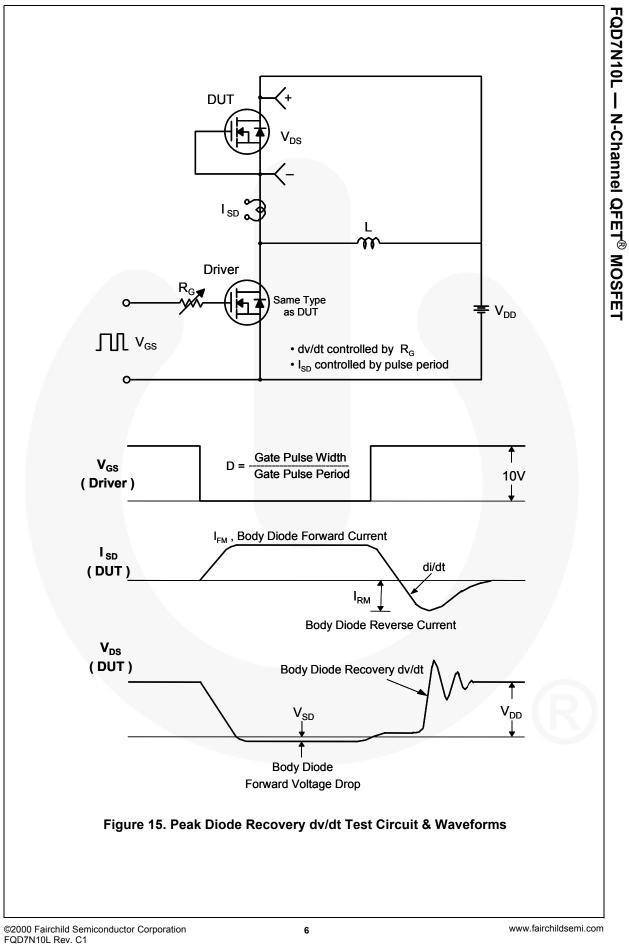
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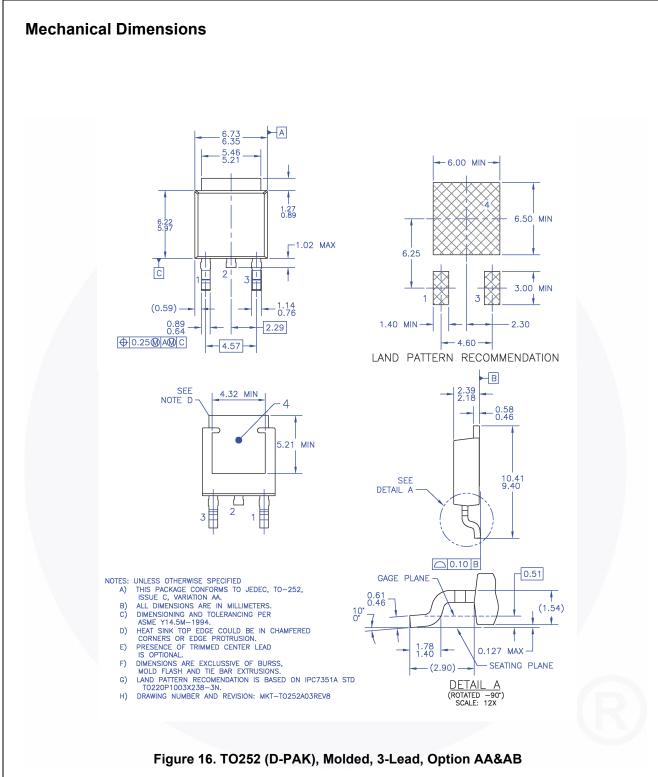


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Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
		Rev. 166

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